

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





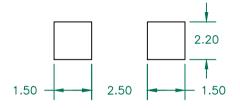


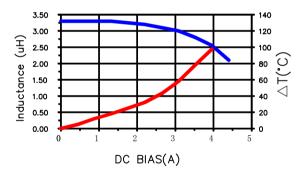
MGV04023R3M-10

PHYSICAL DIMENSIONS:

Α	4.50	<u>±</u>	0.50
В	4.10	\pm	0.30
С	2.00	±	0.30
D	1.50	\pm	0.30
Ε	1.00	\pm	0.50

LAND PATTERNS FOR REFLOW SOLDERING

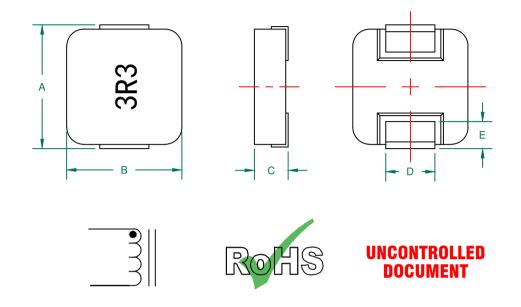




ELECTRICAL SPECIFICATION @ 25°C

	Min	Norm	Max
INDUCTANCE (uH) L @ 100 KHz/0.25V ± 20%	2.64	3.30	3.96
DCR (Ω)			0.087

Saturation Current ³ Isat (A)	4.00	
Temperature Rise Current Irms ⁴ (A)	2.50	



NOTES: UNLESS OTHERWISE SPECIFIED

- 1.COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2.OPERATION TEMPERATURE RANGE: -40°C~+125°C (INCLUDING SELF-HEATING).
- 3.SATURATION CURRENT Isat IS DEFINED AS MAXIMUM AMOUNT OF CURRENT BY WHICH INDUCTANCE WILL DROP BY TYPICAL VALUE OF 30% OF INITIAL INDUCTANCE (Ta=25±5°C).
- 4.TEMPERATURE RISE CURRENT (Irms): DC CURRENT THAT CAUSES THE TEMPERATURE RISE ($\Delta T \leq 40^{\circ}$ C) FROM 25°C AMBIENT.

		DIMENSIONS ARE IN mm.			This print is the property of Laird					
					Tech, and is loaned in confidence subject to return upon request ar	al 🔳		=	.	
					with the understanding that no	~ JL	Laird			
					copies shall be made without the written consent of Laird Tech. All					
ı					rights to design or invention are					
1					reserved.					
ı					PROJECT/PART NUMBER:		PART TY		DRAWN BY:	
ı					MGV04023R3M-10	В		WER CTOR	QIU	
Ī	В	UPDATE LOGO	04/21/15	QIU	DATE: 02/19/13 SC	ALE: N	TS	SHEET:		
	Α	ORIGINAL DRAFT	02/19/13	QIU		OL #	יַ			
İ	REV	DESCRIPTION	DATE	INT		·- 7	-	1	of 1	